

華昕電子 *HI-SINCERITY* SCR

XL 1225 / ML 1225

0.6A 300/400 VOLTAGE **SCR** IGT < 200 μ A

DESCRIPTION

The 1225 Silicon Controlled Rectifiers are high performance diffused PNPN devices. These parts are intended for low cost and high volume applications.

ABSOLUTE MAXIMUM RATING

Parameter	Part No.	Symbol	Min.	Max	Unit	Test Conditions
Repetitive Peak Off State Voltage	XL 1225 ML 1225	V _{DRM}	400		V	T _j =40°C to 125°C (RGK=1K)
On-State Current		I _T (RMS)	0.5		A	T _c =40°C
Average On-State Current		I _T (AV)	0.5		A	Half Cycle=180°C, T _c =40°C
Peak Reverse Gate Voltage		V _G R _M	8		V	I _{GR} =10 μ A
Peak Gate Current		I _{GM}	1		A	10 μ s max.
Gate Dissipation		P _G (AV)	0.1		W	20 ms max.
Operating Temperature		T _j	-40	125	°C	
Storage Temperature		T _{stg}	-40	125	°C	

ELECTRICAL CHARACTERISTICS (TA=25°C)

Parameter		Symbol	Min.	Max	Unit	Test Conditions
Off-State Leakage Current		IDRM		0.1	mA	@ VDRM (RGK=1K) Tj=125°C
Off-State Leakage Current		IDRM		1.0	µA	@ VDRM (RGK=1K) Tj=25°C
On-State Voltage		VT		1.93	V	at IT=0.8A, Tj=25 °C
On-State Threshold Voltage		VT(TO)		0.95	V	Tj=125°C
On-State Slops Resistance		rT		600	m	Tj=125°C
Gate Trigger Current		IGT		200	µA	VD=7V
Gate Trigger Voltage		VGT		0.8	V	VD=7V
Holding Current		IH		5	mA	RGK=1K(ohm)
Latching Current		IL		6	mA	RGK=1K(ohm)
Critical Rate of Voltage Rise		dv/dt	25		V/µs	VD=0.67 ≠ VDRM(RGK=1K), Tj=125°C
Critical Rate of Current Rise		di/dt	30		A/µs	IG=10mA,diG/dt=0, 1A/µs, Tj=125°C
Gate Controlled Delay Time		tgd		500	ns	IG=10mA,diG/dt=0.1A/µs
Commutated Turn-Off Time		tg		200	µs	Tc=85°C , VD=0.67 ≠ VDRM VR=35V, IT=IT(AV)
Thermal Resistance junc. to case		R Θjc	100	K/W		
Thermal Resistance junc. to amb.		R Θja	200	K/W		

PIN ASSIGNMENT (TO-92 PACKAGE)

K : Cathode

G : Gate

A : Anode

FRONT VIEW

